捷多邦,专业PCB打样工厂,24小时加**SN74L**VC16374A 16-BIT EDGE-TRIGGERED D-TYPE FLIP-FLOP WITH 3-STATE OUTPUTS

SCAS663D - MARCH 2001 - REVISED AUGUST 2003

- Member of the Texas Instruments
 Widebus™ Family
- Typical V_{OLP} (Output Ground Bounce)
 <0.8 V at V_{CC} = 3.3 V, T_A = 25°C
- Typical V_{OHV} (Output V_{OH} Undershoot)
 >2 V at V_{CC} = 3.3 V, T_A = 25°C
- I_{off} Supports Partial-Power-Down Mode Operation
- Supports Mixed-Mode Signal Operation on All Ports (5-V Input and Output Voltages With 3.3-V VCC)
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 1000-V Charged-Device Model (C101)

description/ordering information

This 16-bit edge-triggered D-type flip-flop is designed for 1.65-V to 3.6-V V_{CC} operation.

The SN74LVC16374A is particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers. The device can be used as two 8-bit flip-flops or one 16-bit flip-flop. On the positive transition of the clock (CLK) input, the Q outputs of the flip-flop take on the logic levels set up at the data (D) inputs.

DGG, DGV, OR DL PACKAGE
(TOP VIEW)

				1
1OE	1	O	48	1CLK
1Q1	2		47] 1D1
1Q2	3		46	1D2
GND	4		45	GND
1Q3	5		44] 1D3
1Q4	6		43] 1D4
V_{CC}	7		42] v _{cc}
1Q5	8		41	D5 1D5
1Q6	9		40	1D6
GND	[] 10		39	GND
1Q7	[] 11		38	
1Q8	[] 12		37	1D8
2Q1	13		36	2D1
2Q2	14		35	2D2
GND	[15		34	GND
2Q3	16		33	2D3
2Q4	[] 17		32	2D4
V_{CC}	[18		31] v _{cc}
2Q5	[19		30	2D5
2Q6	20		29	2D6
GND	21		28	GND
2Q7	[] 22		27	2D7
2Q8	[] 23		26	2D8
2OE	24		25	2CLK
	_	-	Н	750

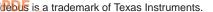
A buffered output-enable (\overline{OE}) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without interface or pullup components.

ORDERING INFORMATION

TA	PACKAGE [†]		ORDERABLE PART NUMBER	TOP-SIDE MARKING
	0000 01	Tube	SN74LVC16374ADL	11/0400744
	SSOP – DL	Tape and reel	SN74LVC16374ADLR	LVC16374A
4000 to 0500	TSSOP - DGG	Tape and reel	SN74LVC16374ADGGR	LVC16374A
-40°C to 85°C	TVSOP – DGV	Tape and reel	SN74LVC16374ADGVR	LD374A
	VFBGA – GQL		SN74LVC16374AGQLR	L D0744
A COLL	VFBGA – ZQL (Pb-free)	Tape and reel	SN74LVC16374AZQLR	LD374A

Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

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SN74LVC16374A

16-BIT EDGE-TRIGGERED D-TYPE FLIP-FLOP

WITH 3-STATE OUTPUTS

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description/ordering information

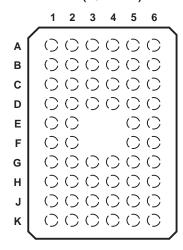
OE does not affect internal operations of the flip-flop. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down, $\overline{\text{OE}}$ should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of this device as a translator in a mixed 3.3-V/5-V system environment.

This device is fully specified for partial-power-down applications using I_{off}. The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

GQL OR ZQL PACKAGE (TOP VIEW)



terminal assignments

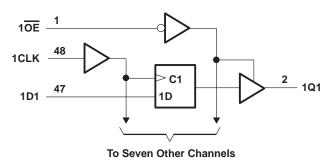
	1	2	3	4	5	6
Α	1OE	NC	NC	NC	NC	1CLK
В	1Q2	1Q1	GND	GND	1D1	1D2
С	1Q4	1Q3	Vcc	Vcc	1D3	1D4
D	1Q6	1Q5	GND	GND	1D5	1D6
E	1Q8	1Q7			1D7	1D8
F	2Q1	2Q2			2D2	2D1
G	2Q3	2Q4	GND	GND	2D4	2D3
Н	2Q5	2Q6	Vcc	Vcc	2D6	2D5
J	2Q7	2Q8	GND	GND	2D8	2D7
K	2OE	NC	NC	NC	NC	2CLK

NC - No internal connection

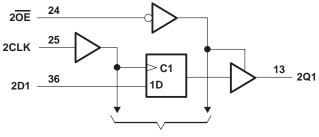
FUNCTION TABLE (each flip-flop)

	INPUTS	OUTPUT	
ŎE,	CLK	D	Q
L	↑	Н	Н
L	\uparrow	L	L
L	H or L	Χ	Q_0
Н	Χ	Χ	Z

logic diagram (positive logic)



Pin numbers shown are for the DGG, DGV, and DL packages.



To Seven Other Channels



SN74LVC16374A 16-BIT EDGE-TRIGGERED D-TYPE FLIP-FLOP WITH 3-STATE OUTPUTS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}		
(see Note 1)		–0.5 V to 6.5 V
Voltage range applied to any output in the high	or low state, V _O	
(see Notes 1 and 2)		. -0.5 V to V _{CC} + 0.5 V
Input clamp current, I _{IK} (V _I < 0)		–50 mA
Output clamp current, I _{OK} (V _O < 0)		
Continuous output current, IO		
Continuous current through each V _{CC} or GND		
Package thermal impedance, θ_{JA} (see Note 3):		
, , , , , , , , , , , , , , , , , , , ,	DGV package	
	DL package	
	GQL/ZQL package	
Storage temperature range, T _{stg}		

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

- 2. The value of V_{CC} is provided in the recommended operating conditions table.
- 3. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 4)

			MIN	MAX	UNIT	
.,	Owner have the me	Operating	1.65	3.6		
VCC	Supply voltage	Data retention only	1.5		V	
		V _{CC} = 1.65 V to 1.95 V	0.65 × V _{CC}			
\vee_{IH}	H High-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7		V	
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2			
		V _{CC} = 1.65 V to 1.95 V		0.35 × V _{CC}		
V_{IL}	Low-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		0.7	V	
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$		0.8		
٧ _I	Input voltage		0	5.5	V	
.,		High or low state	0	VCC	.,	
VO	Output voltage	3-state	0	5.5	V	
		V _{CC} = 1.65 V		-4		
	High level autout augest	V _{CC} = 2.3 V		-8	٦.	
ЮН	High-level output current	V _{CC} = 2.7 V		-12	mA	
		V _{CC} = 3 V		-24		
		V _{CC} = 1.65 V		4		
	Lavorino de colonida como el	V _{CC} = 2.3 V		8	4	
lOL	Low-level output current	$V_{CC} = 2.7 \text{ V}$		12	mA	
		V _{CC} = 3 V		24		
Δt/Δν	Input transition rise or fall rate			10	ns/V	
TA	Operating free-air temperature		-40	85	°C	

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	vcc	MIN	TYP [†]	MAX	UNIT
	I _{OH} = -100 μA	1.65 V to 3.6 V	V _{CC} -0.2			
	$I_{OH} = -4 \text{ mA}$	1.65 V	1.2			
	$I_{OH} = -8 \text{ mA}$	2.3 V	1.7			V
Voн	10 m 4	2.7 V	2.2			V
	I _{OH} = -12 mA	3 V	2.4			
	$I_{OH} = -24 \text{ mA}$	3 V	2.2			
	I _{OL} = 100 μA	1.65 V to 3.6 V			0.2	
	I _{OL} = 4 mA	1.65 V			0.45	
VOL	I _{OL} = 8 mA	2.3 V			0.7	V
	I _{OL} = 12 mA	2.7 V			0.4	
	I _{OL} = 24 mA	3 V			0.55	
lį	V _I = 0 to 5.5 V	3.6 V			±5	μΑ
l _{off}	V _I or V _O = 5.5 V	0			±10	μΑ
loz	$V_0 = 0 \text{ to } 5.5 \text{ V}$	3.6 V			±10	μΑ
	V _I = V _{CC} or GND				20	
^I cc	$3.6 \text{ V} \le \text{V}_1 \le 5.5 \text{ V}^{\ddagger}$ $I_0 = 0$	3.6 V			20	μΑ
ΔlCC	One input at V _{CC} – 0.6 V, Other inputs at V _{CC} or GND	2.7 V to 3.6 V			500	μΑ
C _i	$V_I = V_{CC}$ or GND	3.3 V		5		pF
Co	$V_O = V_{CC}$ or GND	3.3 V		6.5		pF

[†] All typical values are at $V_{CC} = 3.3 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

		V _{CC} = 1.8 V ± 0.15 V		V _{CC} = 2.5 V ± 0.2 V				V _{CC} = 3.3 V ± 0.3 V		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
fclock	Clock frequency		150		150		150		150	MHz
t _W	Pulse duration, CLK high or low	3.3		3.3		3.3		3.3		ns
t _{su}	Setup time, data before CLK↑	2.4		1.6		1.9		1.9		ns
th	Hold time, data after CLK↑	0.8		1		1.1		1.9		ns

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	TO	V _{CC} = ± 0.1	1.8 V 5 V	V _{CC} =	2.5 V 2 V	V _{CC} =	2.7 V	V _{CC} =	3.3 V 3 V	UNIT
	(INPUT)	(OUTPUT)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
f _{max}			150		150		150		150		MHz
t _{pd}	CLK	Q	1	6.5	1	4.3	1	4.9	1.5	4.5	ns
t _{en}	ŌĒ	Q	1	6.7	1	4.7	1	5.3	1.5	4.6	ns
^t dis	ŌĒ	Q	1	10.7	1	5	1	6.1	1.5	5.5	ns
^t sk(o)										1	ns



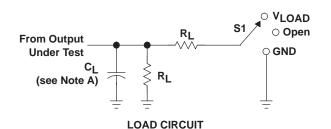
[‡] This applies in the disabled state only.

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operating characteristics, $T_A = 25^{\circ}C$

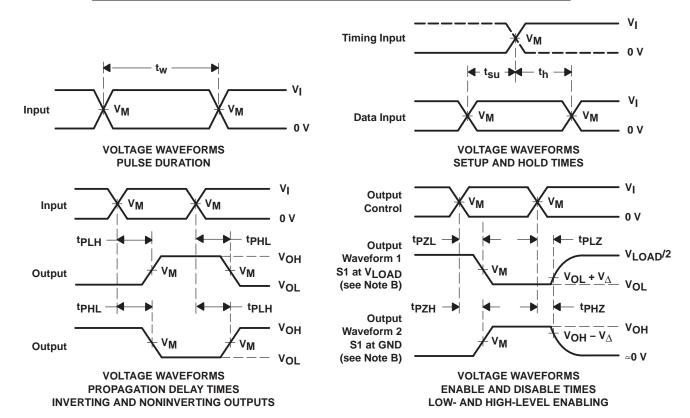
	PARAMETER		TEST	V _{CC} = 1.8 V	$V_{CC} = 2.5 \text{ V}$	$V_{CC} = 3.3 \text{ V}$	UNIT	
			CONDITIONS	TYP	TYP	TYP	UNII	
C _{pd}	Power dissipation capacitance	Outputs enabled	f = 10 MHz	47	52	58	, L	
Фра	per flip-flop	Outputs disabled	1 = 10 WH2	21	23	24	pF	

PARAMETER MEASUREMENT INFORMATION



TEST	S1
tPLH/tPHL	Open
tPLZ/tPZL	V _{LOAD}
tPHZ/tPZH	GND

V = =	INPUT		V	V	C	D.	V
vcc	٧ _I	t _r /t _f	ν _M	VLOAD	CL	R_L	$v_{\scriptscriptstyle\Delta}$
1.8 V ± 0.15 V	VCC	≤2 ns	V _{CC} /2	VCC	30 pF	1 k Ω	0.15 V
2.5 V \pm 0.2 V	VCC	≤2 ns	V _{CC} /2	VCC	30 pF	500 Ω	0.15 V
2.7 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V
3.3 V \pm 0.3 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V



NOTES: A. C_L includes probe and jig capacitance.

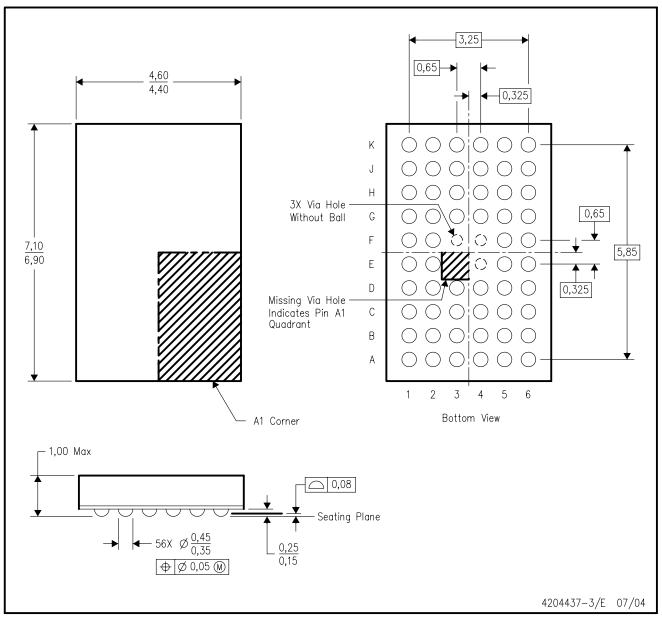
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.
- H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms



ZQL (R-PBGA-N56)

PLASTIC BALL GRID ARRAY



NOTES:

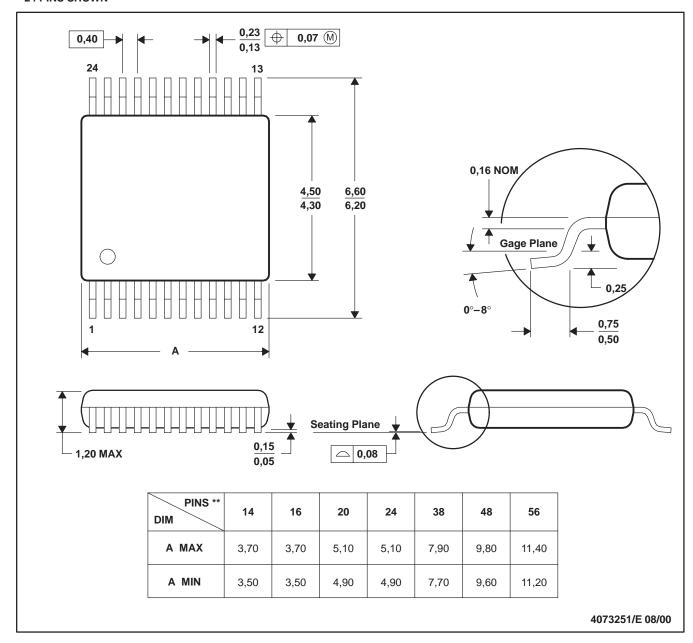
- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MO-225 variation BA.
- D. This package is lead-free. Refer to the 56 GQL package (drawing 4200583) for tin-lead (SnPb).



DGV (R-PDSO-G**)

24 PINS SHOWN

PLASTIC SMALL-OUTLINE



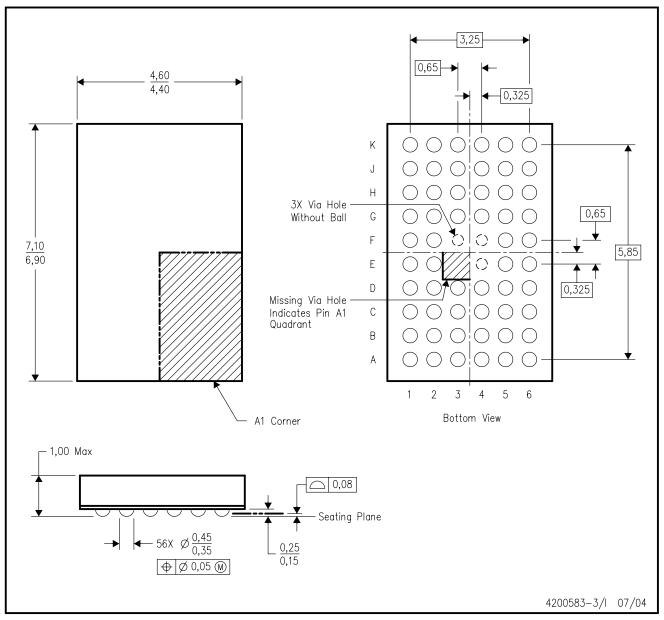
NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
- D. Falls within JEDEC: 24/48 Pins MO-153 14/16/20/56 Pins – MO-194



GQL (R-PBGA-N56)

PLASTIC BALL GRID ARRAY



NOTES:

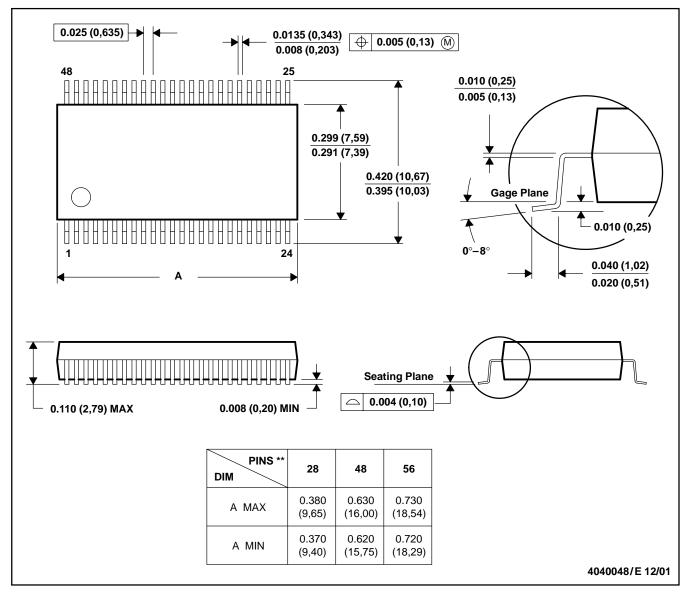
- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MO-225 variation BA.
- D. This package is tin-lead (SnPb). Refer to the 56 ZQL package (drawing 4204437) for lead-free.



DL (R-PDSO-G**)

48 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

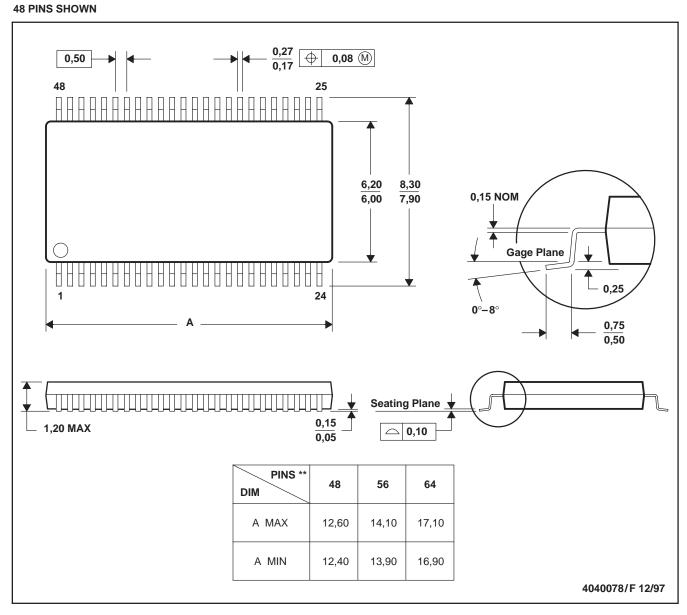
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MO-118



DGG (R-PDSO-G**)

......

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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